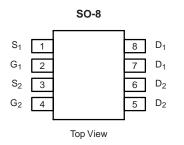




Dual P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^{d, e}	Q _g (Typ.)		
- 30	0.040 at V _{GS} = - 10 V	- 6	15 nC		
- 30	0.048 at V _{GS} = - 4.5 V	- 5	13110		



FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFET

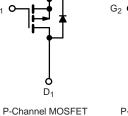
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• 100 % UIS Tested

APPLICATIONS

- Load Switches
 - Notebook PCs
 - Desktop PCs
 - Game Stations





 S_1

 D_2 P-Channel MOSFET

 S_2

C

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	- 30	V	
Gate-Source Voltage		V _{GS}	± 20	V
	T _C = 25 °C		- 6 ^e	
Continuous Drain Current ($T_J = 150 \text{ °C}$)	T _C = 70 °C		- 5 ^e	
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	I _D	- 5 ^{a, b}	
	T _A = 70 °C		- 4 ^{a, b}	A
Pulsed Drain Current		I _{DM}	- 50 ^e	A
Continuous Source-Drain Diode Current	T _C = 25 °C	1-	- 4.1	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 2.0 ^{a, b}	
Avalanche Current	L = 0.1 mH	I _{AS}	- 20	
Single-Pulse Avalanche Energy		E _{AS}	20	mJ
	T _C = 25 °C		5.0	
Maximum Dawar Dissinction	T _C = 70 °C	P _D	3.2	w
Maximum Power Dissipation	T _A = 25 °C		2.5 ^{a, b}	VV
	T _A = 70 °C		1.6 ^{a, b}	
Operating Junction and Storage Temperature Range	T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS Symbol Parameter Typical Maximum Unit Maximum Junction-to-Ambient^{a, c} $t \le 10 \text{ s}$ $\mathsf{R}_{\mathsf{thJA}}$ 38 50 °C/W Maximum Junction-to-Foot 25 Steady State R_{thJF} 20

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under Steady State conditions is 85 °C/W.

d. Based on T_C = 25 °C.

e. Limited by package.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 050.04		- 31		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		4.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 3.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55 \text{ °C}$			- 1 - 5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	- 30		- 3	A	
	D(01)	$V_{GS} = -10 \text{ V}, \text{ I}_D = -7.3 \text{ A}$		0.040			
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -6.2 \text{ A}$		0.048		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 9.1 A		23		S	
Dynamic ^b					•		
Input Capacitance	C _{iss}			880			
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		215		pF	
Reverse Transfer Capacitance	C _{rss}			185			
Total Gate Charge	Qg	V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 9.1 A			20		
					15	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -9.1 \text{ A}$			4		
Gate-Drain Charge	Q _{gd}				5		
Gate Resistance	Rg	f = 1 MHz		5.8	45	Ω	
Turn-On Delay Time	t _{d(on)}			10	15	-	
Rise Time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{L} = 15 \Omega$		8	15		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 1 Ω		45	70		
Fall Time	t _f			12	25	ns	
Turn-On Delay Time	t _{d(on)}			42	70	-	
Rise Time	t _r	$V_{DD} = -15 V, R_L = 15 \Omega$		35	60		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		40	70		
Fall Time	t _f			16	30		
Drain-Source Body Diode Characterist	T	T 07 00					
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			- 4.1	A	
Pulse Diode Forward Current	I _{SM}				- 32		
Body Diode Voltage	V _{SD}	$I_{S} = -2 A, V_{GS} = 0 V$		- 0.75	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			34	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 2 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		22	40	nC	
Reverse Recovery Fall Time	t _a	······································		11		ns	
Reverse Recovery Rise Time	t _b			23			

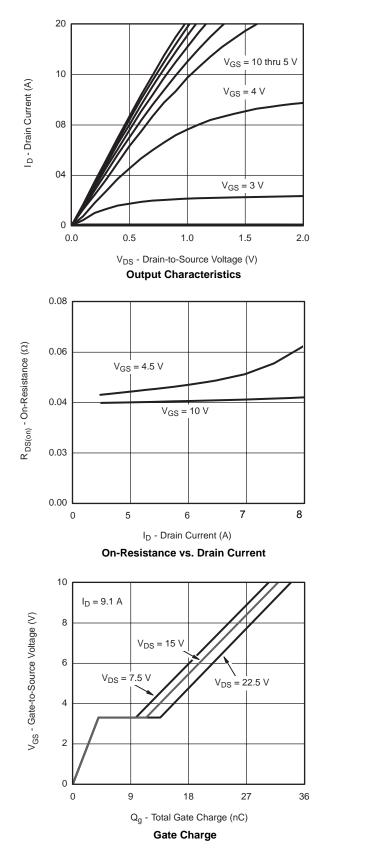
Notes:

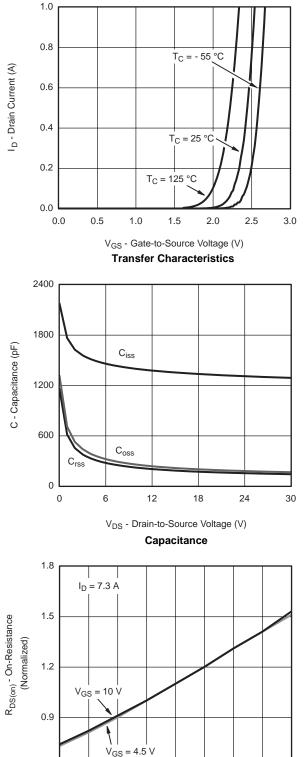
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.







0.6

- 50

- 25

0

25

50

T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature

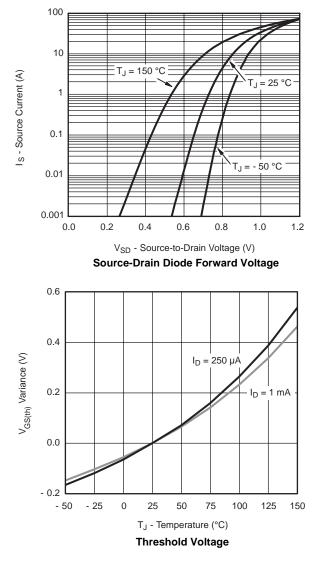
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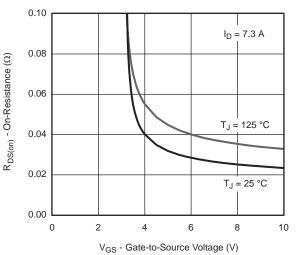
100

125 150

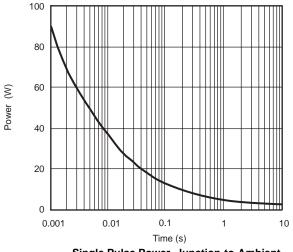




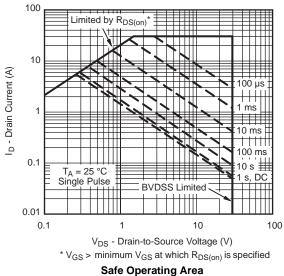




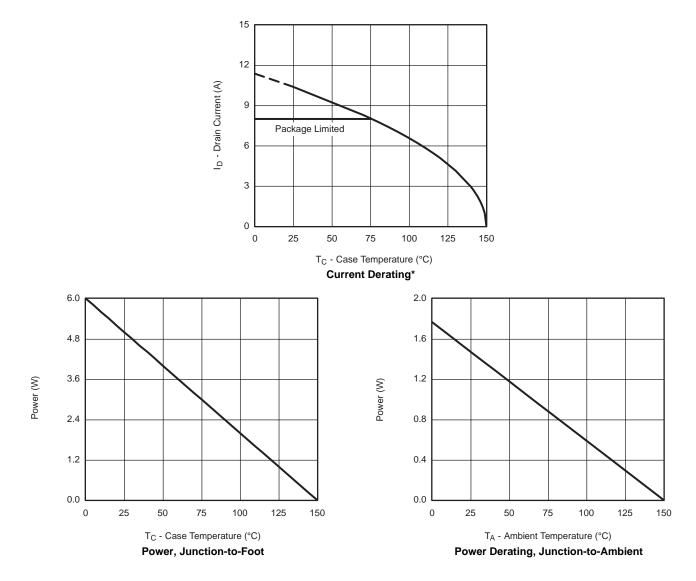
On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

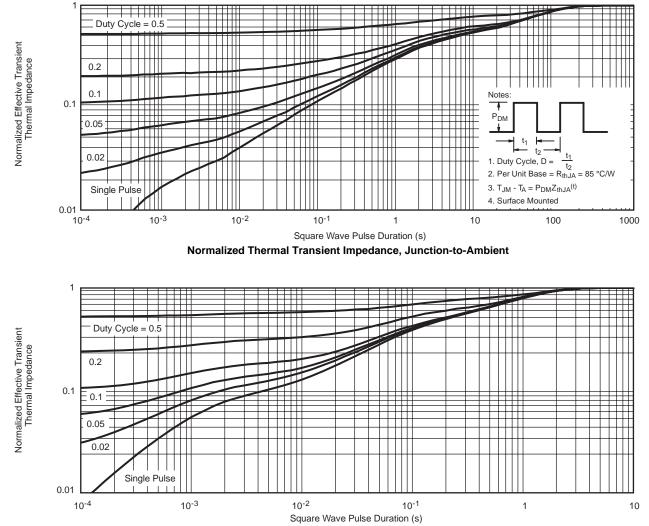






* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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